IPC ASSOCIATION CONNECT ELECTRONICS INDUSTR	© Copyright 2005. IP	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					eous Materia	ials and Mfg Information				
upplier Infor	mation														
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
nsemi												2025-05-14			
ontact Name		Title - Contact			I	Phone - Contact*					Email - Contact*				
Product-Env-Stev	wards	Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com					
uthorized Repre	sentative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
roduct-Env-Stev	wards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com					
Reques	Requester Item Number Mfr Ite		em Number Mfr Item Name				Effective Date	Vers	rsion Manufacturing Site		ring Site	V	Veight*	UOM	Unit Type
		FSBB10CH120DF SPM3V INV 1200V		OV 10A Opt		2025-05-14	14 CPA			1	6491.803	mg	Each		
	g Proccess Informat											,			·
, , , , , , , , , , , , , , , , , , ,		,		I-STD-020 MSI	L Rating	Peak Process Body Temperature Max 7			me at Peak	1		r of Reflow Cy	cles		
Matte Tin (Sn) - annealed			CU Alloy NA 0 C 30 seconds 3												
omments															
r more informa	tion regarding material o	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is trought in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
DBC	1880.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		752	mg
			Supplier	Copper (Cu)	7440-50-8		1128	mg
Die	67.7	mg	Supplier	Silicon (Si)	7440-21-3		67.7	mg
Die Attach	31.4	mg	Supplier	Silver (Ag)	7440-22-4		0.785	mg
			Supplier	Tin (Sn)	7440-31-5		29.045	mg
			Supplier	Copper (Cu)	7440-50-8		1.57	mg
Die Attach2	0.163	mg	Supplier	Poly(oxypropylene)diamine	9046-10-0		0.0049	mg
			Supplier	Miscellaneous	Trade Secret		0.0082	mg
			Supplier	Silver (Ag)	7440-22-4		0.1386	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0114	mg
Lead Frame	4318.38	mg	Supplier	Silver (Ag)	7440-22-4		1.47	mg
			Supplier	Iron (Fe)	7439-89-6		5.18	mg
			Supplier	Copper (Cu)	7440-50-8		4309.998	mg
			Supplier	Phosphorus (P)	7723-14-0		1.73	mg
Mold Compound-Black	10122.0	mg	Supplier	Polymer(phenyl glycidil ether)-co- dicyclopentadiene	119345-05-0		404.88	mg
			Supplier	4,4'-Bis(2,3-epoxypropoxy)-3,3',5,5'-tetramethylbiphenyl	85954-11-6		404.88	mg
			Supplier	Carbon Black (C)	1333-86-4		50.61	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		8755.5303	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		101.22	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		404.88	mg
Plating	53.3	mg	Supplier	Tin (Sn)	7440-31-5		53.3	mg
Wire Bond - Al	18.3	mg	Supplier	Aluminum (Al)	7429-90-5		18.3	mg
Wire Bond - Cu	0.56	mg	Supplier	Copper (Cu)	7440-50-8		0.56	mg